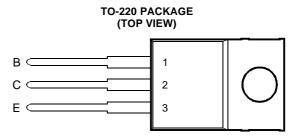
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- Designed for Complementary Use with TIP130, TIP131 and TIP132
- 70 W at 25°C Case Temperature
- 8 A Continuous Collector Current
- Minimum h_{FE} of 1000 at 4 V, 4 A



Pin 2 is in electrical contact with the mounting base.

MDTRACA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT	
	TIP135		-60		
Collector-base voltage ($I_E = 0$)	TIP136	V _{CBO}	-80	V	
	TIP137		-100		
	TIP135		-60		
Collector-emitter voltage ($I_B = 0$)	TIP136	V _{CEO}	-80	V	
	TIP137		-100		
Emitter-base voltage		V _{EBO}	-5	V	
Continuous collector current		Ι _C	-8	A	
Peak collector current (see Note 1)		I _{CM}	-12	A	
Continuous base current			-0.3	A	
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P _{tot}	70	W	
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P _{tot}	2	W	
Unclamped inductive load energy (see Note 4)		½LI _C ²	75	mJ	
Operating junction temperature range			-65 to +150	°C	
Storage temperature range			-65 to +150	°C	
Lead temperature 3.2 mm from case for 10 seconds		T _{stg} T _L	260	°C	

NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%.$

- 2. Derate linearly to 150°C case temperature at the rate of 0.56 W/°C.
- 3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.
- 4. This rating is based on the capability of the transistor to operate safely in a circuit of: L = 20 mH, $I_{B(on)}$ = -5 mA, R_{BE} = 100 Ω , $V_{BE(off)}$ = 0, R_S = 0.1 Ω , V_{CC} = -20 V.





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electrical characteristics at 25°C case temperature

	PARAMETER		TEST	CONDITIONS		MIN	TYP	MAX	UNIT
V _{(BR)CEO}	Collector-emitter breakdown voltage	I _C = -30 mA	I _B = 0	(see Note 5)	TIP135 TIP136 TIP137	-60 -80 -100			V
I _{CEO}	Collector-emitter cut-off current	$V_{CE} = -30 V$ $V_{CE} = -40 V$ $V_{CE} = -50 V$	$I_{B} = 0$ $I_{B} = 0$ $I_{B} = 0$		TIP135 TIP136 TIP137			-0.5 -0.5 -0.5	mA
I _{CBO}	Collector cut-off current	$V_{CB} = -60 V$ $V_{CB} = -80 V$	$I_{E} = 0$ $I_{E} = 0$ $I_{E} = 0$	$T_{C} = 100^{\circ}C$ $T_{C} = 100^{\circ}C$ $T_{C} = 100^{\circ}C$	TIP135 TIP136 TIP137 TIP135 TIP136 TIP137			-0.2 -0.2 -0.2 -1 -1 -1	mA
I _{EBO}	Emitter cut-off current	V _{EB} = -5 V	l _C = 0					-5	mA
h _{FE}	Forward current transfer ratio	$V_{CE} = -4 V$ $V_{CE} = -4 V$	$I_{\rm C} = -1 \text{ A}$ $I_{\rm C} = -4 \text{ A}$	(see Notes 5 and	16)	500 1000		15000	
V _{CE(sat)}	Collector-emitter saturation voltage	$I_B = -16 \text{ mA}$ $I_B = -30 \text{ mA}$	I _C = -4 A I _C = -6 A	(see Notes 5 and 6)				-2 -3	V
V_{BE}	Base-emitter voltage	V _{CE} = -4 V	I _C = -4 A	(see Notes 5 and	16)			-2.5	V
C _{obo}	Output capacitance	V _{CB} = -10 V	$I_E = 0$					200	pF
V_{EC}	Parallel diode forward voltage	I _E = -8 A	I _B = 0	(see Notes 5 and	16)			-3.5	V

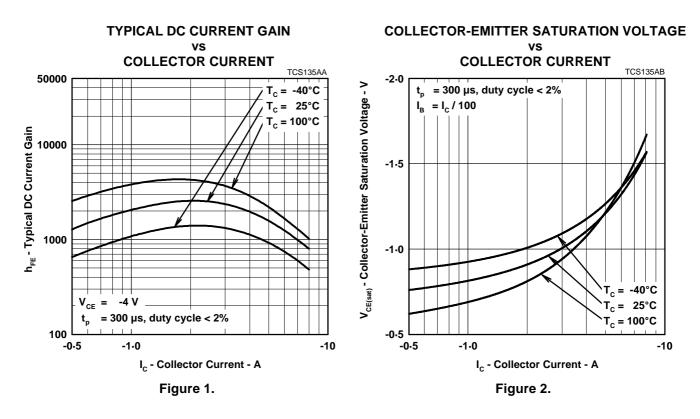
NOTES: 5. These parameters must be measured using pulse techniques, t_p = 300 $\mu s,$ duty cycle \leq 2%.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

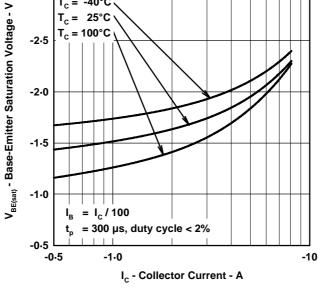
PARAMETER		MIN	ТҮР	MAX	UNIT
R _{θJC}	Junction to case thermal resistance			1.78	°C/W
R_{\thetaJA}	Junction to free air thermal resistance			62.5	°C/W

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TYPICAL CHARACTERISTICS

BASE-EMITTER SATURATION VOLTAGE vs **COLLECTOR CURRENT** TCS135AC -3-0 -40°C T_c = 25°C T_c = = 100°C Tc -2.5

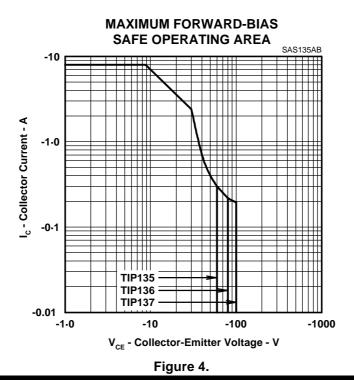




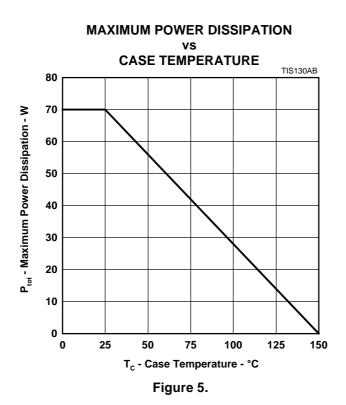


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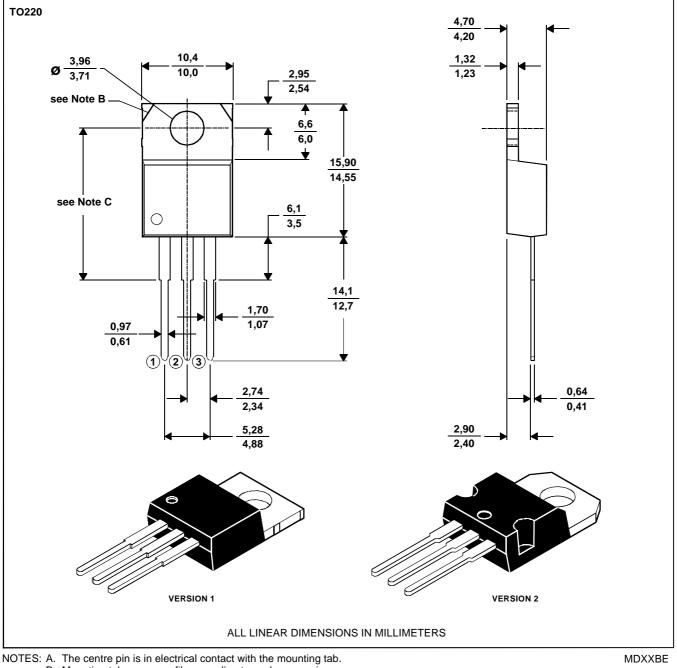
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MECHANICAL DATA

TO-220

3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



B. Mounting tab corner profile according to package version.

C. Typical fixing hole centre stand off height according to package version.

Version 1, 18.0 mm. Version 2, 17.6 mm.

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